

1571182-1 ✓ ACTIVE

TE Internal #: 1571182-1

Housing, Receptacle, Wire-to-Board, 3 Position, 2.54 mm [.1 in]  
Centerline, Insulation Displacement (IDC), Black, Wire & Cable,  
Signal

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Connectors > PCB Connectors > Wire-to-Board Connectors > Wire-to-Board Connector Assemblies & Housings



Connector Product Type: **Housing**

Connector & Housing Type: **Receptacle**

Connector System: **Wire-to-Board**

Number of Positions: **3**

Centerline (Pitch): **2.54 mm [.1 in]**

## Features

### Product Type Features

Connector Product Type	Housing
Connector & Housing Type	Receptacle
Connector System	Wire-to-Board
Sealable	No
Connector & Contact Terminates To	Wire & Cable

### Configuration Features

Number of Positions	3
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### Contact Features

Contact Current Rating (Max)	3 A
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### Termination Features

Termination Method to Wire & Cable	Insulation Displacement (IDC)
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### Mechanical Attachment

Mating Retention	Without
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Connector Mounting Type	Cable Mount (Free-Hanging)
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### Housing Features

Centerline (Pitch)	2.54 mm [.1 in]
Housing Color	Black

### Usage Conditions

Operating Temperature Range	-65 – 105 °C [-85 – 221 °F]
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### Operation/Application

Circuit Application	Signal
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### Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not applicable for solder process capability

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

### Compatible Parts



## Documents

### Product Drawings

[MTE RCPT HSG,SGL ROW,MOD LATCH](#)

English

### CAD Files

[3D PDF](#)

3D

Customer View Model

[ENG\\_CVM\\_CVM\\_1571182-1\\_B.2d\\_dxf.zip](#)

English

Customer View Model

[ENG\\_CVM\\_CVM\\_1571182-1\\_B.3d\\_igs.zip](#)

English

Customer View Model

[ENG\\_CVM\\_CVM\\_1571182-1\\_B.3d\\_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

### Datasheets & Catalog Pages

[AMPMODU MTE INTERCONNECT SYSTEM](#)

English

### Product Specifications

[Product Specification](#)

English